

ACMME 2026

The 14th Asia Conference on Mechanical and Materials Engineering

Osaka, Japan
June 22-26, 2026

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ACMME 2026 Speakers



Ninshu Ma
Osaka University, Japan

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Important Dates

Submission Deadline	February 1, 2026
Notification Due	March 1, 2026
Registration Deadline	March 20, 2026

Publication

Option 1 Springer



Accepted and registered papers with presentation will be published into **Lecture Notes in Mechanical Engineering**, which is indexed by **Ei Compendex, Scopus, SCImago**, etc. All books published in the series are submitted for consideration in **Web of Science (CPCI)**.

Option 2 Scientific.Net

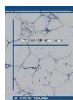
Accepted and registered papers with presentation will be published in below listed journals of **Scientific.Net** collection, which will be indexed by **Scopus**, etc.



Materials Science Forum (MSF)



Solid State Phenomena (SSP)



Defect and Diffusion Forum (DDF)



Key Engineering Materials (KEM)



IET Nanodielectrics (ISSN:2514-3255)

Impact Factor: 2.7

2022 CiteScore: 6.1; JCI: 0.39

Indexing: **ESCI, EI, Scopus, IET Inspec, DOAJ**

Publication History

ACMME 2024 - Vol. 1131 - Material Science Forum (MSF).

ACMME 2023 - Vol. 1110 - Material Science Forum (MSF).

ACMME 2022 - Vol. 1075 - Material Science Forum (MSF).

ACMME 2021 - Vol. 1074 - Material Science Forum (MSF).

ACMME 2020 - Vol. 1015 - Material Science Forum (MSF).

ACMME 2019 - Vol. 975 - Materials Science Forum (MSF).

ACMME 2018 - Vol. 934 - Materials Science Forum (MSF).

ACMME 2017 - Vol. 909 - Materials Science Forum (MSF).

ACMME 2016 - Vol. 880 - Materials Science Forum (MSF).

ACMME 2015 - Vol. 26(2015) - MATEC Web of Conferences.

Papers of **ACMME 2022, ACMME 2021, ACMME 2020, ACMME 2019, ACMME 2018, ACMME 2017, ACMME 2016 & ACMME 2015** are indexed by **Ei Compendex and Scopus**!

More info, please visit: <http://www.acmme.org/2024.html>

Conference Topics

Materials Science

New Materials and Advanced Materials

Environmental Friendly Materials

New Functional Materials

Materials Forming

Microwave Processing of Materials

Rapid Prototyping, Manufacturing, and Tooling

Precision Engineering, and Concurrent Engineering

More topics, please go to: <http://www.acmme.org/cfp.html>

Submission Method

Electronic Submission System:

<http://www.easychair.org/conferences/?conf=acmme2026>

Email Submission: sub@acmme.org

Contact Us

Conference Secretary: Ms. Cara Lee

For paper submission: sub@acmme.org

For paper registration: reg@acmme.org

For ACMME details: info@acmme.org

Tel: +86-18117806403 | +852-3155-4897